

# NTC thermistors for temperature measurement

Glass-encapsulated sensor for high temperatures

Series/Type: B57650H Date: January 2018

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#### Please read Cautions and warnings and Important notes at the end of this document.

### Temperature measurement

### Glass-encapsulated sensor for high temperatures

# Applications

Temperature measurement for high temperatures

### Features

- Glass-encapsulated NTC thermistor, heat-resistant and highly stable
- For temperature measurement up to 650 °C, maximum 1000 h
- Rigid terminals, aluminum oxide rod with silver palladium termination pads on opposite sides
- Short response time
- High measurement accuracy

# Options

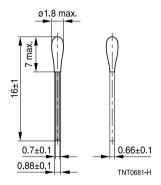
Alternative design options upon request.

### Delivery mode

Blister packing

### General technical data

# Dimensional drawing



Dimensions in mm Approx. weight 50 mg

Climatic category	(IEC 60068-1)		40/600/21	
Resistance tolerance		$\Delta R_{\rm B}/R_{\rm B}$	±2	%
Rated temperature		T <sub>R</sub>	200	°C
Dissipation factor	(in air)	$\delta_{th}$	approx. 1.5	mW/K
Thermal cooling time constant	(in air)	$\tau_{c}$	approx. 10	s
Heat capacity		C <sub>th</sub>	approx. 15	mJ/K

### Electrical specification and ordering codes

R <sub>R</sub> Ω	$\Delta R_{\rm R}/R_{\rm R}$ %	R <sub>25</sub> Ω	No. of R/T characteristic	B <sub>25/200</sub> K	Ordering code
5000	±2	821970	6001	4113 ±1%	B57650H0824A001

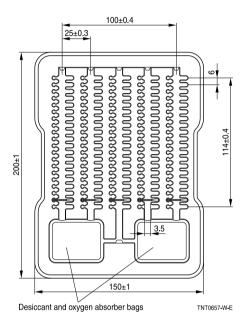
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#### **Blister packing**

Dimensions in mm



#### Mounting instructions for type H650

The H650 type NTC thermistor is not designed for soldering. The contacting technology to be used shall be evaluated and tested based on the application. Options are clamp contacting, conductive adhesion, silver sintering or welding (e.g. thermo-compression welding based on standard DVS M 2921).

During contacting and handling of the NTC thermistor (e.g. welding), it must be ensured that mechanical stress or thermal shock do not damage the component. To avoid high thermal shocks, a preheating of the component is recommended. Insufficient preheating may cause ceramic cracks.

Ensure that no thermo-mechanical stress occurs due to production processes when thermistors are sealed, potted or overmolded or during their subsequent operation. Ensure that the materials used (sealing/potting compound) are chemically neutral.

Please also note the mounting instructions and cautions and warnings in this data book.

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#### **Reliability data**

Test	Standard	Test conditions	$\Delta R_{100}/R_{100}$ (typical)	Remarks
High temperature exposure (storage)		Temperature of air : +600 °C t: 1000 h	< 2%	No visible damage
Temperature exposure (storage)		Temperature of air: +300 °C t: 5000 h	< 1%	No visible damage
Biased humidity	MIL-STD-202, method 103	Temperature of air: +85 °C Relative humidity of air: 85% Test voltage: 0.3 V DC on NTC t: 1000 h	< 2%	No visible damage
Operational life	MIL-STD-202, method 108	Temperature of air: +150 °C Test voltage: 0.2 V DC on NTC t: 1000 h	< 2%	No visible damage
Rapid temperature cycling	JESD 22, method JA-104	Lower test temperature: -40 °C Upper test temperature: +200 °C Dwell time at each temperature: 15 min Transition time in air: max. 1 min Number of cycles: 1000	< 2%	No visible damage
Rapid temperature cycling		Lower test temperature: +105 °C Upper test temperature: +500 °C Dwell time at each temperature: 5 min Transition time in air: max. 1 min Number of cycles: 1000	< 2%	No visible damage
Mechanical shock	MIL-STD-202, method 213, condition C	Acceleration: 40 <i>g</i> Pulse duration: 6 ms Number of bumps in each direction: 3	< 1%	No visible damage
Vibration	MIL-STD-202, method 204	Acceleration: 5 <i>g</i> t: 20 min Number of cycles in each of 3 orientations: 12 Frequency range: 10 2000 Hz	< 1%	No visible damage

#### Note:

The NTC sensor element is not specified for direct contact with aggressive media including water in any aggregate state (liquid, solid or gas). Direct contact with aggressive media may lead to a defect and malfunction of the NTC sensor element. Customer must take appropriate measures to avoid direct contact with aggressive media, e.g. by covering or housing the NTC sensor element.

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### **R/T characteristics**

R/T No.	6001							
T (°C)	B <sub>25/200</sub> = 4113	К	T (°C)	B <sub>25/200</sub> = 4113	К	T (°C)	B <sub>25/200</sub> = 4113	K
	R <sub>T</sub> /R <sub>25</sub>	α (%/K)		R <sub>T</sub> /R <sub>25</sub>	α (%/K)		R <sub>T</sub> /R <sub>25</sub>	α (%/K)
-40.0	22.449	5.6	195.0	0.0067555	2.1	430.0	0.00017663	1.2
-35.0	17.045	5.4	200.0	0.0060829	2.1	435.0	0.00016680	1.1
-30.0	13.029	5.3	205.0	0.0054864	2.0	440.0	0.00015762	1.1
-25.0	10.023	5.2	210.0	0.0049564	2.0	445.0	0.00014902	1.1
-20.0	7.7599	5.1	215.0	0.0044846	2.0	450.0	0.00014098	1.1
-15.0	6.0444	4.9	220.0	0.0040640	2.0	455.0	0.00013345	1.1
-10.0	4.7362	4.8	225.0	0.0036883	1.9	460.0	0.00012639	1.1
-5.0	3.7326	4.7	230.0	0.0033522	1.9	465.0	0.00011978	1.1
0.0	2.9581	4.6	235.0	0.0030510	1.9	470.0	0.00011357	1.1
5.0	2.3571	4.5	240.0	0.0027808	1.8	475.0	0.00010774	1.0
10.0	1.8881	4.4	245.0	0.0025379	1.8	480.0	0.00010227	1.0
15.0	1.5202	4.3	250.0	0.0023193	1.8	485.0	0.000097134	1.0
20.0	1.2300	4.2	255.0	0.0021223	1.8	490.0	0.000092302	1.0
25.0	1.0000	4.1	260.0	0.0019444	1.7	495.0	0.000087758	1.0
30.0	0.81680	4.0	265.0	0.0017836	1.7	500.0	0.000083481	1.0
35.0	0.67017	3.9	270.0	0.0016381	1.7	505.0	0.000079454	1.0
40.0	0.55227	3.8	275.0	0.0015062	1.7	510.0	0.000075661	1.0
45.0	0.45705	3.7	280.0	0.0013866	1.6	515.0	0.000072087	1.0
50.0	0.37980	3.7	285.0	0.0012778	1.6	520.0	0.000068716	1.0
55.0	0.31686	3.6	290.0	0.0011789	1.6	525.0	0.000065536	0.9
60.0 65.0 70.0 75.0 80.0	0.26538 0.22310 0.18824 0.15938 0.13541	3.5 3.4 3.3 3.2	295.0 300.0 305.0 310.0 315.0	0.0010888 0.0010058 0.00092995 0.00086088 0.00079788	1.6 1.6 1.5 1.5 1.5	530.0 535.0 540.0 545.0 550.0	0.000062535 0.000059701 0.000057024 0.000054494 0.000052101	0.9 0.9 0.9 0.9 0.9
85.0 90.0 95.0 100.0 105.0	0.11543 0.098719 0.084690 0.072876 0.062896	3.2 3.1 3.0 3.0 2.9	320.0 325.0 330.0 335.0 340.0	0.00074032 0.00068765 0.00063938 0.00059509 0.00055438	1.5 1.5 1.4 1.4 1.4	555.0 560.0 565.0 570.0 575.0	0.000049838 0.000047695 0.000045667 0.000043745 0.000041924	0.9 0.9 0.9 0.9 0.9 0.8
110.0 115.0 120.0 125.0 130.0	0.054439 0.047251 0.041124 0.035885 0.031395	2.9 2.8 2.8 2.7 2.6	345.0 350.0 355.0 360.0 365.0	0.00051692 0.00048241 0.00045059 0.00042120 0.00039405	1.4 1.4 1.3 1.3	580.0 585.0 590.0 595.0 600.0	0.000040197 0.000038559 0.000037004 0.000035529 0.000034127	0.8 0.8 0.8 0.8 0.8
135.0	0.027535	2.6	370.0	0.00036893	1.3	605.0	0.000032795	0.8
140.0	0.024208	2.6	375.0	0.00034566	1.3	610.0	0.000031529	0.8
145.0	0.021334	2.5	380.0	0.00032410	1.3	615.0	0.000030325	0.8
150.0	0.018845	2.5	385.0	0.00030411	1.3	620.0	0.000029180	0.8
155.0	0.016683	2.4	390.0	0.00028554	1.3	625.0	0.000028090	0.8
160.0	0.014802	2.4	395.0	0.00026829	1.2	630.0	0.000027052	0.7
165.0	0.013157	2.3	400.0	0.00025225	1.2	635.0	0.000026063	0.7

Please read *Cautions and warnings* and *Important notes* at the end of this document.

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Temperature measurement

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R/T No.	6001							
T (°C)	B <sub>25/200</sub> = 4113 K		T (°C)	B <sub>25/200</sub> = 4113 K		T (°C)	B <sub>25/200</sub> = 4113 K	
	$R_T/R_{25}$	α (%/K)		R <sub>T</sub> /R <sub>25</sub>	α (%/K)		R <sub>T</sub> /R <sub>25</sub>	α (%/K)
170.0	0.011718	2.3	405.0	0.00023733	1.2	640.0	0.000025121	0.7
175.0	0.010457	2.3	410.0	0.00022343	1.2	645.0	0.000024223	0.7
180.0	0.0093497	2.2	415.0	0.00021049	1.2	650.0	0.000023367	0.7
185.0	0.0083749	2.2	420.0	0.00019841	1.2	-	-	-
190.0	0.0075152	2.1	425.0	0.00018715	1.2	-	-	-

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**Temperature measurement** 

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#### Cautions and warnings

#### General

See "Important notes" on page 2.

#### Storage

- Store thermistors only in original packaging. Do not open the package prior to processing.
- Storage conditions in original packaging: storage temperature -25 °C ... +45 °C, relative humidity ≤75% annual mean, <95% maximum 30 days per annum, dew precipitation is inadmissible.</p>
- Do not store thermistors where they are exposed to heat or direct sunlight. Otherwise, the packing material may be deformed or components may stick together, causing problems during mounting.
- Avoid contamination of thermistor surface during storage, handling and processing.
- Avoid storage of thermistors in harmful environments like corrosive gases (SO<sub>x</sub>, CI etc).
- Use the components as soon as possible after opening the original packaging.
- Solder thermistors within the time specified after shipment from EPCOS. For leaded components this is 24 months, for SMD components with nickel barrier termination 12 months, for leadless components this is 12 months, for SMD components with AgPd termination 6 months.

#### Handling

- NTC thermistors must not be dropped. Chip-offs or any other damage must not be caused during handling of NTCs.
- Do not touch components with bare hands. Gloves are recommended.
- Avoid contamination of thermistor surface during handling.
- Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.

#### Bending / twisting leads

A lead (wire) may be bent at a minimum distance of twice the wire's diameter plus 4 mm from the component head or housing. When bending ensure the wire is mechanically relieved at the component head or housing. The bending radius should be at least 0.75 mm.

#### Soldering

- Use resin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.

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#### Mounting

- Ensure that no thermo-mechanical stress occurs due to production processes (curing or overmolding processes) when thermistors are sealed, potted or overmolded or during their subsequent operation. The maximum temperature of the thermistor must not be exceeded. Ensure that the materials used (sealing/potting compound and plastic material) are chemically neutral.
- Electrodes/contacts must not be scratched or damaged before/during/after the mounting process.
- Contacts and housing used for assembly with the thermistor must be clean before mounting.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of the thermistor. Be sure that surrounding parts and materials can withstand the temperature.
- Avoid contamination of the thermistor surface during processing.
- The connections of sensors (e.g. cable end, wire end, plug terminal) may only be exposed to an environment with normal atmospheric conditions.
- Tensile forces on cables or leads must be avoided during mounting and operation.
- Bending or twisting of cables or leads directly on the thermistor body is not permissible.
- Avoid using chemical substances as mounting aids. It must be ensured that no water or other liquids enter the NTC thermistors (e.g. through plug terminals). In particular, water based substances (e.g. soap suds) must not be used as mounting aids for sensors.
- The use of no-clean solder products is recommended. In any case mild, non-activated fluxes should be used. Flux residues after soldering should be minimized.

#### Operation

- Use thermistors only within the specified operating temperature range.
- Use thermistors only within the specified power range.
- Environmental conditions must not harm the thermistors. Only use the thermistors under normal atmospheric conditions or within the specified conditions.
- Contact of NTC thermistors with any liquids and solvents shall be prevented. It must be ensured that no water enters the NTC thermistors (e.g. through plug terminals). For measurement purposes (checking the specified resistance vs. temperature), the component must not be immersed in water but in suitable liquids (e.g. perfluoropolyethers such as Galden).
- Avoid dewing and condensation unless thermistor is specified for these conditions.
- Bending or twisting of cables and/or wires is not permissible during operation of the sensor in the application.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by malfunction.

This listing does not claim to be complete, but merely reflects the experience of EPCOS AG.

#### Display of ordering codes for EPCOS products

The ordering code for one and the same EPCOS product can be represented differently in data



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# Symbols and terms

Symbol	English	German
A	Area	Fläche
AWG	American Wire Gauge	Amerikanische Norm für Drahtquerschnitte
В	B value	B-Wert
B <sub>25/100</sub>	B value determined by resistance	B-Wert, ermittelt durch Widerstands-
	measurement at 25 $^\circ\text{C}$ and 100 $^\circ\text{C}$	messungen bei 25 °C und 100 °C
C <sub>th</sub>	Heat capacitance	Wärmekapazität
I	Current	Strom
Ν	Number (integer)	Anzahl (ganzzahliger Wert)
P <sub>25</sub>	Maximum power at 25 °C	Maximale Leistung bei 25 °C
$P_{diss}$	Power dissipation	Verlustleistung
P <sub>el</sub>	Electrical power	Elektrische Leistung
P <sub>max</sub>	Maximum power within stated	Maximale Leistung im
	temperature range	angegebenenTemperaturbereich
$\Delta R_B/R_B$	Resistance tolerance caused by	Widerstandstoleranz, die durch die
	spread of B value	Streuung des B-Wertes verursacht wird
<b>R</b> <sub>ins</sub>	Insulation resistance	Isolationswiderstand
R <sub>P</sub>	Parallel resistance	Parallelwiderstand
R <sub>R</sub>	Rated resistance	Nennwiderstand
$\Delta R_{\rm R}/R_{\rm R}$	Resistance tolerance	Widerstandstoleranz
Rs	Series resistance	Serienwiderstand
R <sub>τ</sub>	Resistance at temperature T	Widerstand bei Temperatur T
	(e.g. $R_{25}$ = resistance at 25 °C)	(z.B. $R_{25}$ = Widerstand bei 25 °C)
т	Temperature	Temperatur
$\Delta T$	Temperature tolerance	Temperaturtoleranz
t	Time	Zeit
T <sub>A</sub>	Ambient temperature	Umgebungstemperatur
T <sub>max</sub>	Upper category temperature	Obere Grenztemperatur
_		(Kategorietemperatur)
$T_{min}$	Lower category temperature	Untere Grenztemperatur
		(Kategorietemperatur)
T <sub>op</sub>	Operating temperature	Betriebstemperatur
T <sub>R</sub>	Rated temperature	Nenntemperatur
$T_{surf}$	Surface temperature	Oberflächentemperatur
V	Voltage	Spannung
V <sub>ins</sub>	Insulation test voltage	Isolationsprüfspannung
V <sub>op</sub>	Operating voltage	Betriebsspannung
V <sub>test</sub>	Test voltage	Prüfspannung

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Symbol	English	German
α	Temperature coefficient	Temperaturkoeffizient
$\Delta$	Tolerance, change	Toleranz, Änderung
$\delta_{\text{th}}$	Dissipation factor	Wärmeleitwert
$\tau_{c}$	Thermal cooling time constant	Thermische Abkühlzeitkonstante
$\tau_{a}$	Thermal time constant	Thermische Zeitkonstante

#### **Abbreviations / Notes**

Symbol	English	German
SMD	Surface-mounted devices	Oberflächenmontierbares Bauelement
*	To be replaced by a number in ordering codes, type designations etc.	Platzhalter für Zahl im Bestellnummern- code oder für die Typenbezeichnung.
+	To be replaced by a letter.	Platzhalter für einen Buchstaben.
	All dimensions are given in mm.	Alle Maße sind in mm angegeben.
	The commas used in numerical values denote decimal points.	Verwendete Kommas in Zahlenwerten bezeichnen Dezimalpunkte.

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- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
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 B57620C5103K062
 B59970C0080A070
 199-303KAF-A02
 GA100K6MBD1
 B57423V2473H062
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 B57230V2103H260
 B57471V2684H062
 B57471V2333H062
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 NTCALUG01A103G
 NTCALUG01A103G
 B57421V2153J062
 B57230V2103H260
 B57471V2684H062
 B57471V2333H062
 126-153YJC-B01